TE Internal #: 1-2232960-3

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.

098 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Signal, Natural

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Features

Product Type Features

| PCB Connector Type | PCB Mount Header |
|-----------------------------------|-----------------------|
| Connector System | Wire-to-Board |
| Header Type | Fully Shrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Connector Product Type | Connector Assembly |
| Caufin matica Factures | |

Configuration Features

| PCB Mount Orientation | Vertical |
|-----------------------|----------|
| Number of Positions | 3 |
| Number of Rows | 1 |

Electrical Characteristics

Body Features

| Primary Product Color | Natural | |
|-----------------------|---------|--|
|-----------------------|---------|--|



Contact Features

| Contact Underplating Material | Nickel |
|---|-------------------|
| PCB Contact Termination Area Plating Material Finish | Matte |
| Contact Mating Area Plating Material Thickness | 1.27 μm[50.8 μin] |
| Mating Tab Width | 1.5 mm[.059 in] |
| PCB Contact Termination Area Plating Material Thickness | 3.8 μm[149.6 μin] |
| Contact Shape & Form | Square |
| Contact Layout | Inline, Staggered |
| Contact Base Material | Copper Alloy |
| Mating Tab Thickness | .6 mm[.024 in] |
| PCB Contact Termination Area Plating Material | Tin |
| | |
| Contact Mating Area Plating Material Finish | Matte |
| Contact Mating Area Plating Material Finish Contact Mating Area Plating Material | Matte Tin (Sn) |
| | |

Termination Features

| Termination Post & Tail Length | 2.9 mm[.11 in] |
|--|-----------------------|
| Square Termination Post & Tail Dimension | .6 mm[.023 in] |
| Termination Method to PCB | Through Hole - Solder |

Mechanical Attachment

| Mating Retention Type | Latch |
|--------------------------|---------------------|
| Mating Retention | With |
| Mating Alignment Type | Keyed, Polarization |
| PCB Mount Retention Type | None |
| PCB Mount Alignment Type | Locating Posts |
| PCB Mount Retention | Without |
| PCB Mount Alignment | With |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| | |

Housing Features

| Housing Material | PA 66 GF |
|--------------------|-----------------|
| Centerline (Pitch) | 2.5 mm[.098 in] |

Dimensions



| Connector Height | 15.5 mm[.61 in] |
|-----------------------------|----------------------------|
| Connector Length | 10.1 mm[.39 in] |
| Usage Conditions | |
| Housing Temperature Rating | Standard |
| Operating Temperature Range | -40 - 120 °C[-40 - 248 °F] |
| Operation/Application | |
| Solder Process Feature | Board Standoff |
| Circuit Application | Signal |
| Industry Standards | |

Industry Standards

| Glow Wire Rating | Glow Wire |
|------------------------|-----------|
| UL Flammability Rating | UL 94V-0 |

Packaging Features

| Packaging Method | Box, Carton |
|------------------|-------------|

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Not reviewed for solder process capability |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on



requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought



NC D1.0





THV



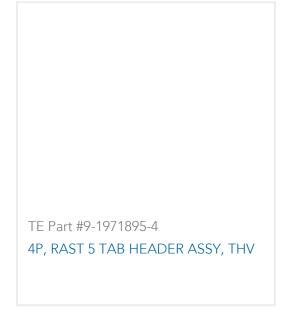












Documents

Product Drawings
3P POTTED RAST 2.5 HEADER

English

3P POTTED RAST 2.5 HEADER

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, Natural



English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-2232960-3_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-2232960-3_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-2232960-3_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

RAST Connector System Catalog

English

Product Specifications

Product Specification

English

Agency Approvals

VDE Certificate

English